

# HSF

**NOTES:**

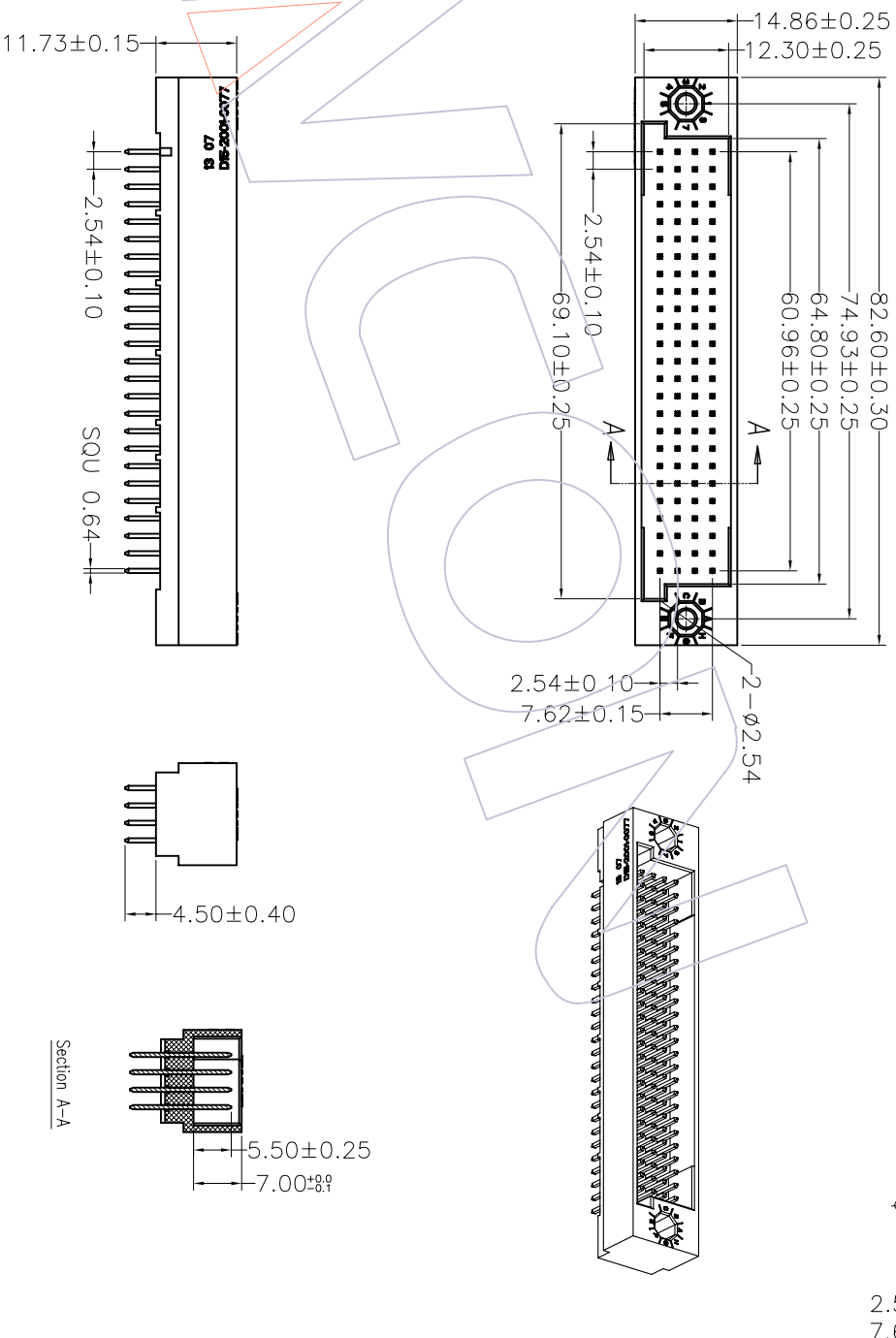
Current Rating:3AMP  
 Contact Resistance:30mΩ max  
 Withstand Voltage:500V AC/DC  
 Insulation Resistance:1000MΩ min  
 Operation Temperature:-40°C to +105°C  
 Contact Material:Phosphor bronze  
 Contact plating: Au 3U", and plated Au area over Pd Ni 30U", other area plated fog Sn 100U" over Ni 30U"-50U"  
 Insulator Material:LCP+30%GF (UL94V-0)

## Ordering Information

3410-4 25 A M S XX N X 1

- Contact Plating
- G0=Gold Flash
- G1=3u"Gold
- G2=5u"Gold
- G3=10u"Gold
- G4=15u"Gold
- G5=30u"Gold
- S0=Gold Flash/Tin
- S1=3u"Gold/Tin
- S2=5u"Gold/Tin
- S3=10u"Gold/Tin
- S4=15u"Gold/Tin
- S5=30u"Gold/Tin
- SN=Tim

- Packing
- A=Tray
- T=Tube



Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.	TITLE:
A0	08/06/13	NEW			X.X ±0.40	DESIGN	08/06/13	1:1	3410-425AMSXXXX1	2.54 DIN HEADER (EUROPE TYPE)
					X.XX ±0.25	CHECK		A4		
					X.XXX ±0.15	CHECK		1/1		
					Angle ± 3'	APPROVE		PROU.		Customer NO.

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